



HMC520LC4

GaAs MMIC I/Q MIXER 6 - 10 GHz

Typical Applications

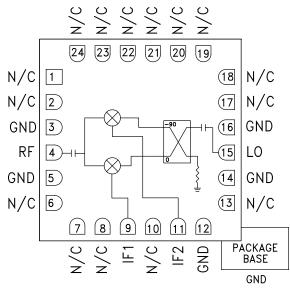
The HMC520LC4 is ideal for:

- Point-to-Point and Point-to-Multi-Point Radio
- Digital Radio
- VSAT

Features

Wide IF Bandwidth: DC - 3.5 GHz Image Rejection: 40 dB LO to RF Isolation: 50 dB High Input IP3: +23 dBm 24 Lead 4x4mm SMT Package: 16mm²

Functional Diagram



General Description

The HMC520LC4 is a compact I/Q MMIC mixer in a leadless "Pb free" SMT package, which can be used as either an Image Reject Mixer or a Single Sideband Upconverter. The mixer utilizes two standard Hittite double balanced mixer cells and a 90 degree hybrid fabricated in a GaAs MESFET process. A low frequency quadrature hybrid was used to produce a 100 MHz USB IF output. This product is a much smaller alternative to hybrid style Image Reject Mixers and Single Sideband Upconverter assemblies. The HMC520LC4 eliminates the need for wire bonding allowing use of surface mount manufacturing techniques.

Electrical Specifications, $T_A = +25$ °C, IF= 100 MHz, LO = +15 dBm*

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, RF/LO	6 - 10			7.1 - 8.5			GHz
Frequency Range, IF		DC - 3.5 DC - 3.5			GHz		
Conversion Loss (As IRM)		7	10		7	9	dB
Image Rejection	20	30		28	40		dB
1 dB Compression (Input)		+12			+12		dBm
LO to RF Isolation	35	45		40	50		dB
LO to IF Isolation	16	20		18	22		dB
IP3 (Input)		+22			+23		dBm
Amplitude Balance		0.3			0.2		dB
Phase Balance		4			4		Deg

* Unless otherwise noted, all measurements performed as downconverter.



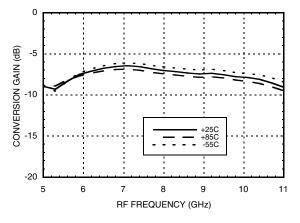
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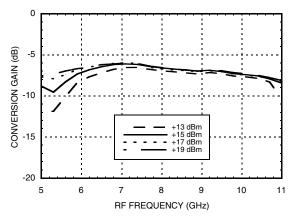


Data Taken As IRM With External IF Hybrid

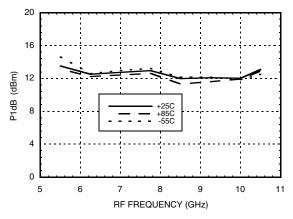
Conversion Gain vs. Temperature



Conversion Gain vs. LO Drive

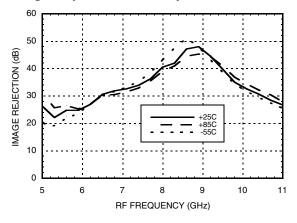


Input P1dB vs. Temperature

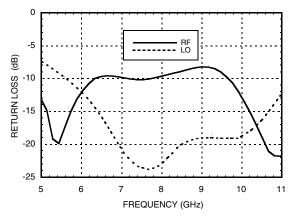


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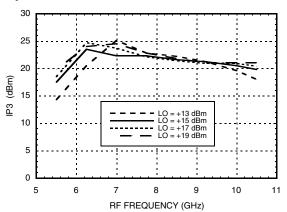
Image Rejection vs. Temperature



Return Loss



Input IP3 vs. LO Drive



MIXERS, I/Q MIXERS, IRMS & RECEIVERS - SMT



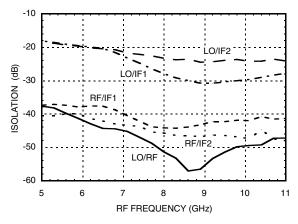
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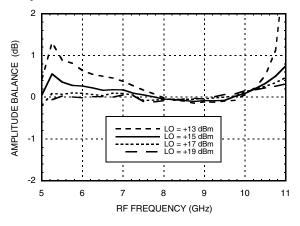
ROHS V

Quadrature Channel Data Taken Without IF Hybrid

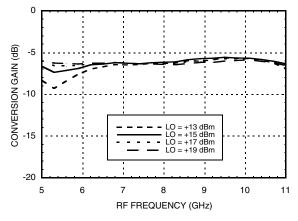
Isolations



Amplitude Balance vs. LO Drive

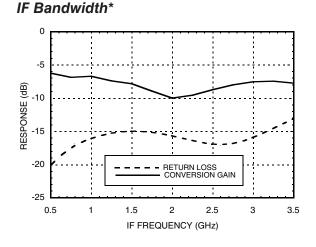


Upconverter Performance Conversion Gain vs. LO Drive

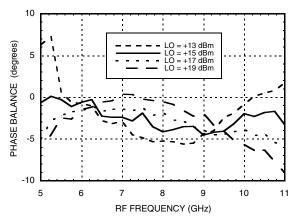


* Conversion gain data taken with external IF hybrid

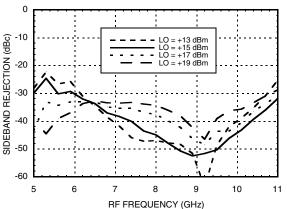
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Phase Balance vs. LO Drive



Upconverter Performance Sideband Rejection vs. LO Drive



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Harmonics of LO

LO Freq. (GHz)	nLO Spur at RF Port				
	1	2	3	4	
5.5	40	41	51	54	
6.5	44	48	45	69	
7.5	52	62	55	68	
8.5	52	66	58	55	
9.5	59	69	47		
10.5 47 60 62 xx					
LO = + 15 dBm Values in dBc below input LO level measured at RF Port.					

Absolute Maximum Ratings

	•
RF / IF Input	+20 dBm
LO Drive	+ 27 dBm
Channel Temperature	150°C
Continuous Pdiss (T=85°C) (derate 6.9 mW/°C above 85°C)	508 mW
Thermal Resistance (R _{TH}) (junction to package bottom)	128.2 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-55 to +85 °C

MxN Spurious Outputs

	nLO				
mRF	0	1	2	3	4
0	xx	-6	37	21	61
1	31	0	47	60	68
2	90	69	72	69	90
3	90	90	90	79	90
4	90	90	90	99	90

RF = 7.6 GHz @ -10 dBm

LO = 7.5 GHz @ +15 dBm

Data taken without IF hybrid

All values in dBc below IF power level



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS



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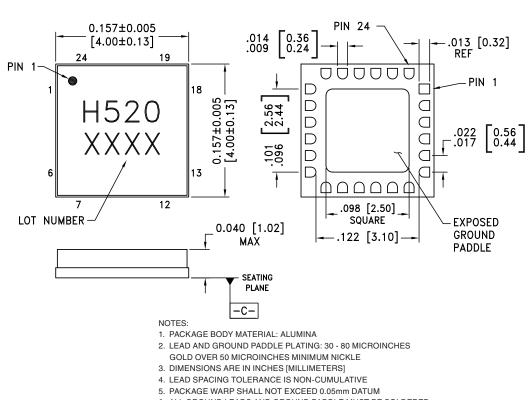
6 - 10 GHz

GaAs MMIC I/Q MIXER

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Outline Drawing



BOTTOM VIEW

6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[2]
HMC520LC4	Alumina, White	Gold over Nickel	MSL3 ^[1]	H520 XXXX

[1] Max peak reflow temperature of 260 °C [2] 4-Digit lot number XXXX

[2] 4-Digit lot number XXXX



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Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 2, 6 - 8, 10, 13, 17 - 24	N/C	No connection required. These pins may be connected to RF/DC ground without affecting performance.	
3, 5, 12, 14, 16	GND	These pins and package bottom must be connected to RF/DC ground.	
4	RF	This pin is AC coupled and matched to 50 Ohms from 6 to 10 GHz.	RF ○
9	IF1	This pin is DC coupled. For applications not requir- ing operation to DC, this port should be DC blocked externally using a series capacitor whose value has	
11	IF2	been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source/sink more than 3mA of current or part non-function and possible part failure will result.	
15	LO	This pin is AC coupled and matched to 50 Ohms from 6 to 10 GHz.	L0 0

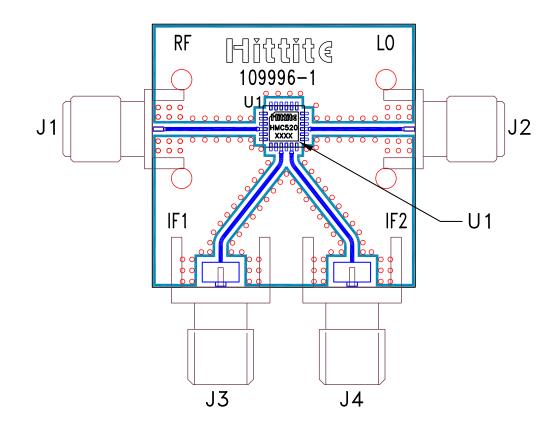


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Evaluation PCB



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List of Materials for Evaluation PCB 109998 [1]

Item	Description
J1, J2	PCB Mount SMA RF Connector, SRI
J3 - J4	PCB Mount SMA Connector, Johnson
U1	HMC520LC4
PCB [2]	109996 Evaluation Board

Reference this number when ordering complete evaluation PCB
Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

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